	Туре	L#	Hits	Search Text	DBs
1	BRS	L1	1365	257/698.ccls.	US-PGPUB; USPAT; USOCR
2	BRS	L2	1175	257/691.ccls.	US-PGPUB; USPAT; USOCR
3	BRS	L3	901	257/693.ccls.	US-PGPUB; USPAT; USOCR
4	BRS	L4	1739	257/712.ccls.	US-PGPUB; USPAT; USOCR
5	BRS	L5	585	257/730.ccls.	US-PGPUB; USPAT; USOCR
6	BRS	L6	312	257/698.ccls.	EPO; JPO; DERWENT; IBM_TDB
7	BRS	L7	358	257/730.ccls.	EPO; JPO; DERWENT; IBM_TDB
8	BRS	L8	955	257/712.ccls.	EPO; JPO; DERWENT; IBM_TDB
9	BRS	L9		((die or chip) and (substrate or board) and (stiffener or frame or ring) and current and power and ground and copper).clm.	US-PGPUB